

## SOT-363 Plastic-Encapsulate MOSFETS

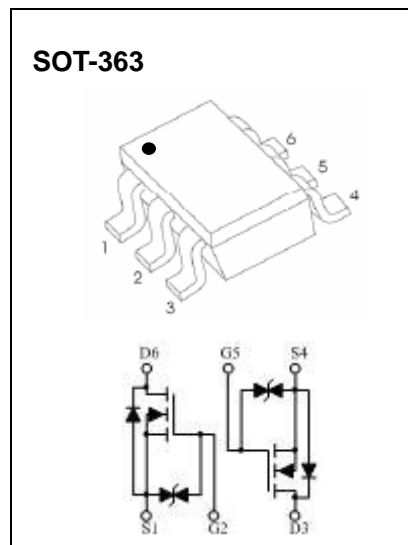
### CJ3134KDW Dual N-Channel MOSFET

#### FEATURE

- Lead Free Product is Acquired
- Surface Mount Package
- N-Channel Switch with Low  $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive
- Equivalent to Two CJ3134K

#### APPLICATION

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift



#### MARKING: 34K

#### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	20	V
Gate-source voltage	$V_{GS}$	$\pm 12$	V
Continuous drain current ( $t \leq 10\text{s}$ )	$I_D$	0.75	A
Power dissipation*	$P_D$	0.15	W
Thermal resistance from junction to ambient	$R_{\theta JA}$	833	$^{\circ}\text{C/W}$
Junction temperature	$T_J$	150	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$	-55~ +150	$^{\circ}\text{C}$

\* Repetitive rating : Pulse width limited by junction temperature.

**ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> = 0V			±50	μA
Gate threshold voltage (note 1)	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.35		1	V
Drain-source on-resistance (note 1)	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.65A			380	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =0.55A			450	mΩ
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =0.45A			800	mΩ
Forward tranconductance (note 1)	g <sub>FS</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =0.8A		1.6		S
Diode forward voltage(note 1)	V <sub>SD</sub>	I <sub>S</sub> =0.15A, V <sub>GS</sub> = 0V			1.2	V
<b>DYNAMIC PARAMETERS (note 2)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =16V, V <sub>GS</sub> =0V, f =1MHz		79	120	pF
Output Capacitance	C <sub>oss</sub>			13	20	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			9	15	pF
<b>SWITCHING PARAMETERS(note 2)</b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =0.5A, R <sub>GEN</sub> =10Ω		6.7		ns
Turn-on rise time	t <sub>r</sub>			4.8		ns
Turn-off delay time	t <sub>d(off)</sub>			17.3		ns
Turn-off fall time	t <sub>f</sub>			7.4		ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =7A		20		nC
Gate-Source Charge	Q <sub>gs</sub>			1		nC
Gate-Drain Charge	Q <sub>gd</sub>			4		nC

**Notes :**

1. Pulse Test : Pulse width≤300μs, duty cycle≤0.5%.
2. Guaranteed by design, not subject to production testing.

